Submission under 37 C.F.R. §1.114 Application No. 10/719,020 Attorney Docket No. 032130

## **AMENDMENTS TO THE SPECIFICATION**

Please amend the title of the invention as follows:

PLATING BATH FOR FORMING THIN RESISTANCE LAYER, METHOD FOR PREPARING A CIRCUIT BOARD MATERIAL HAVING OF FORMATION OF RESISTANCE LAYER, A CONDUCTIVE BASE AND A [[WITH]] RESISTANCE LAYER, AND CIRCUIT BOARD MATERIAL WITH RESISTANCE LAYER